

LCD MODULE SPECIFICATION

Model:	UE019QV-AB40-L001A
Version:	V2.0
Date:	2024-07-29

Customer Confirmation

Approved by	Notes

Please return one of the copies of the specification with your signature to us within two weeks after you receive this document. If it is not returned, we will assume that you agree to the entire contents of this specification document.

VIEWE Confirmation

Prepared by	Reviewed by	Approved by

REVISION HISTORY

Revision	Date	Contents of Revision Change	Remark
V1.0	2023-07-29	Preliminary release	

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1. GENERAL INFORMATION

1.1 Features

- 1) Pixel Arrangement: RGB Vertical Stripe
- 2) Interface Mode: MCU 8/16BIT/SPI
- 3) Driver IC: GC9307
- 4) Operation Temperature: -20~70°C
- 5) Storage Temperature: -30~80°C
- 6) Backlight Type: White LED
- 7) Display mode: Normally Black,
- 8) Pixel Density: 182 PPI
- 9) LED life time: 30,000 Hours

1.2 Mechanical Specification

Item	Specification	Unit	Remark
Pixel Driving element	IPS TFT	-	-
Screen Size	1.99	Inch	Diagonal
Resolution	170(W)*3(RGB)*320(H)	Dots	-
Interface	MCU 8/16BIT/SPI	-	40PIN
Module Power Consumption	0.28	Watt	Typ.
Active Area	22.695(W)*42.72(H)	mm	-
Pixel pitch (W*H)	0.1335(W)*0.1335(H)	mm	-
Module Size (W*H*D)	25.80(W)*49.72(H)*1.59(D)	mm	-
Luminance	550	cd/m ²	Typ.
Viewing Direction	ALL	O'clock	-
Display Color	262K	Colors	18bits

2. ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min.	Max.	Unit	Remark
Power supply voltage1	IOVCC	-0.5	3.6	V	Note1
Power supply voltage2	VCI	-0.5	3.6	V	Note1
LED forward current	I _F	-0.001	40	mA	For each led,Note1
LED Reverse Voltage	V _R	-	2.9	V	For each led,Note1
Operating temperature	T _{op}	-20	70	°C	Note1,2
Storage temperature	T _{st}	-30	80	°C	Note1,2
Humidity	H _{st}	10	90	%RH	Note1,3

(Ta=+25°C,GND=0V)

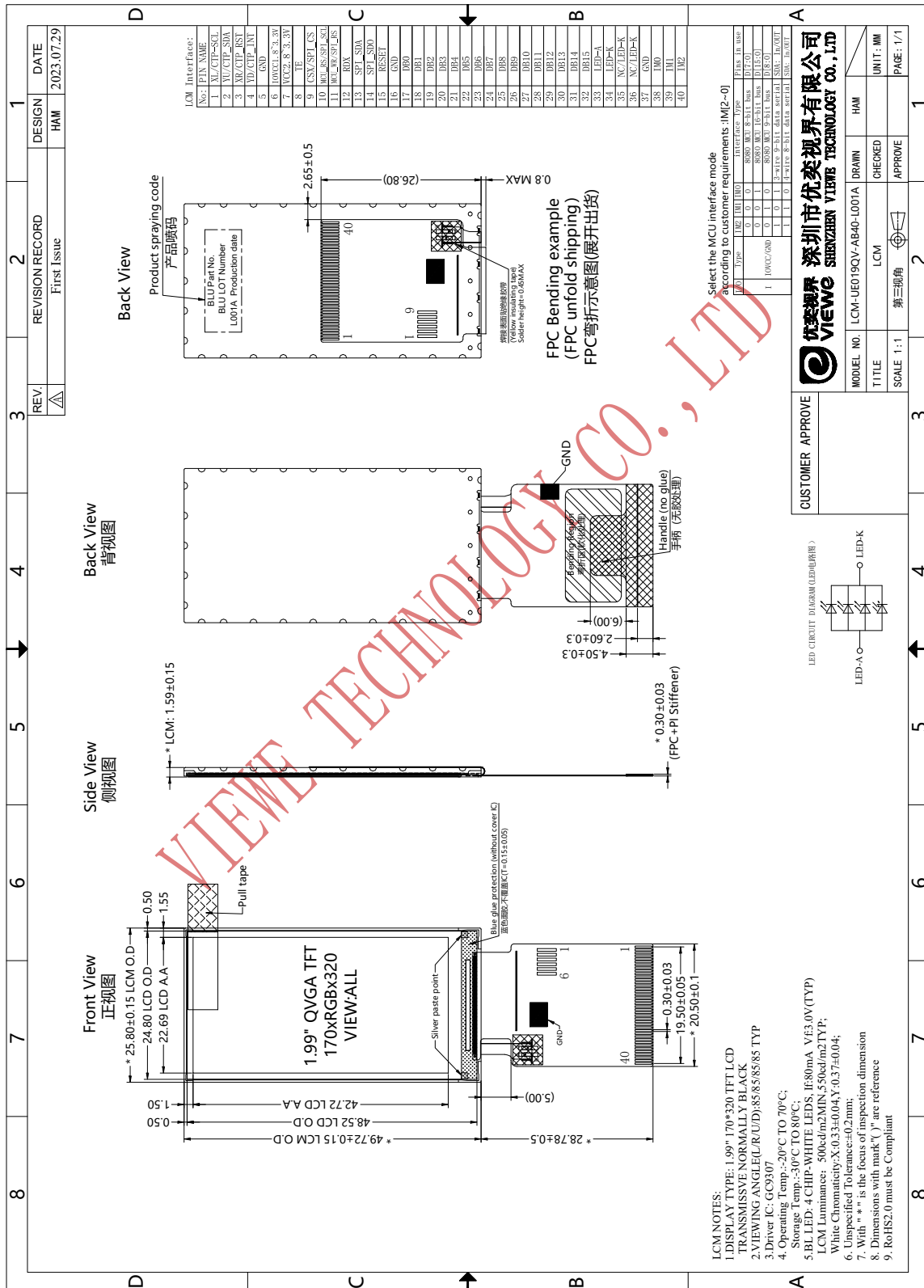
Note1: If the module exceeds the absolute maximum ratings, it may be damaged permanently. Also if the module operates with the absolute maximum ratings for a long time, the reliability may drop.

Note2: In case of temperature below 0°C, the response time of liquid crystal (LC) becomes slower and the color of panel darker than normal one.

Note3: Temp. ≤ 60°C , 90% RH MAX.

Temp. >60°C , Absolute humidity shall be less than 90% RH.

3. MECHANICAL DRAWING



4. Input Terminal Pin Assignment

I: Input; O: Output; P: Power

Pin No.	Symbol 符号	I/O	Description 描述
1	XL /CTP-SCL	I	I2C clock signals for CTP; Option XL for RTP
2	YU /CTP-SDA	I	I2C data signal for CTP, Option YU for RTP
3	XR /CTP-RST	I	The signal will reset the CTP,Signal is active low, Option XR for RTP
4	YD /CTP-INT	I/O	Interrupt signals for CTP, Option YD for RTP
5	GND	P	Power Ground
6	IOVCC	P	Power supply for I/O system
7	VCI	P	Power supply for analog circuits
8	TE	O	Tearing effect signal is used to synchronize MCU to frame memory
9	SPI_CS /MCU_CS	I	Chip selection pin. Low-active
10	SPI_SCL /MCU_RS	I	Display data/command selection pin in MCU interface In SPI mode, this pin is used as SCL
11	SPI_RS /MCU_WR	I	Write enable in MCU parallel interface RS=1 display data or parameter;RS=0 register index / command
12	MCU_RD	I	Read enable in 8080 MCU parallel interface. Low-active.
13	SPI_SDA	I/O	Serial communication data input and output, internal pull low.
14	SPI_SDO	O	SPI interface output pin
15	RESET	I	The signal will reset the LCM, Signal is active low.
16	GND	P	Power Ground
17-32	DB0-DB15	I/O	data bus for MCU
33	LED-A	P	Power supply for backlight anode
34-36	LED-K	P	Power supply for backlight cathode
37	GND	P	Power Ground
38	IM0	I	The MCU interface mode select.
39	IM1	I	The MCU interface mode select.
40	IM2	I	The MCU interface mode select.

I: Input; O: Output; P: Power

5. ELECTRICAL CHARACTERISTICS

5.1 TFT-LCD Panel Driving Section

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Power Supply Voltage1	IOVCC	3.0	3.3	3.6	V	-
Power Supply Voltage2	VCC	3.0	3.3	3.6	V	-
Power Supply Current1	I _{iovcc}	-	-	-	mA	Note1
Power Supply Current2	I _{vcc}	-	12	-	mA	Note1
Logic Input High Voltage	V _{IH}	0.7VDD	-	VDD	V	-
Logic Input Low Voltage	V _{IL}	0	-	0.3VDD	V	-
Panel Power Consumption	P _{VDD}	-	0.04	-	Watt	Note1
Module Power Consumption	P _{LCM}	-	0.28	-	Watt	Note1,2

(Ta=+25°C,GND=0V)

Note1:Measurement Conditions (Video Mode): Full Screen Red Pattern,VDD=3.3V,60Hz Refresh.

Note2: P_{LCM}= P_{VDD}+ P_{B/L}, About P_{B/L} information, inference to 5.2 Back Light Driving Section.

5.2 Back Light Driving Section

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Forward Voltage	-	-	2.9	-	V	Note1
Forward Current	I _F	-	80	-	mA	Note1
Backlight Power consumption	P _{B/L}	-	0.24	-	Watt	Note1
LED life time	-	30000	-	-	Hrs	Note2
LED Quantity			4		PCS	

(Ta=+25°C,GND=0V)

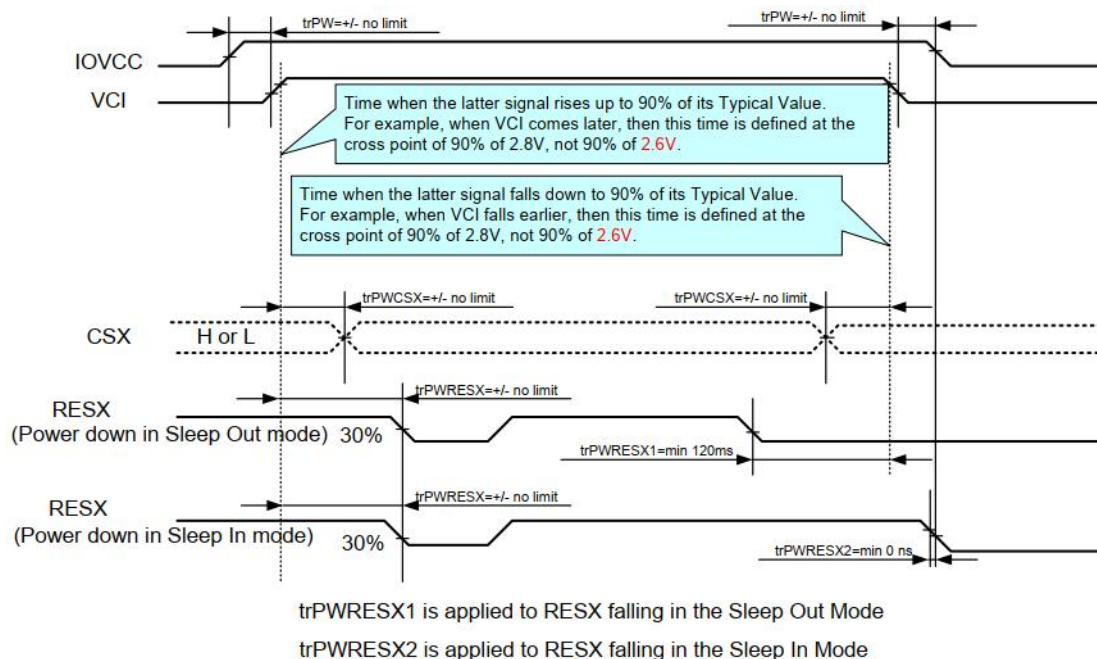
Note1: The LED driving condition is defined for each LED module

Note2: The “LED life time” is defined as the module brightness decrease to 50% of original brightness at I_{LED}=20mA(Per Led). The LED life time could be decreased if operating I_{LED} is larger than 20mA.

5.3 Power On/Off

5.3.1 Case 1 - RESX Line is Held High or Unstable by Host at Power ON

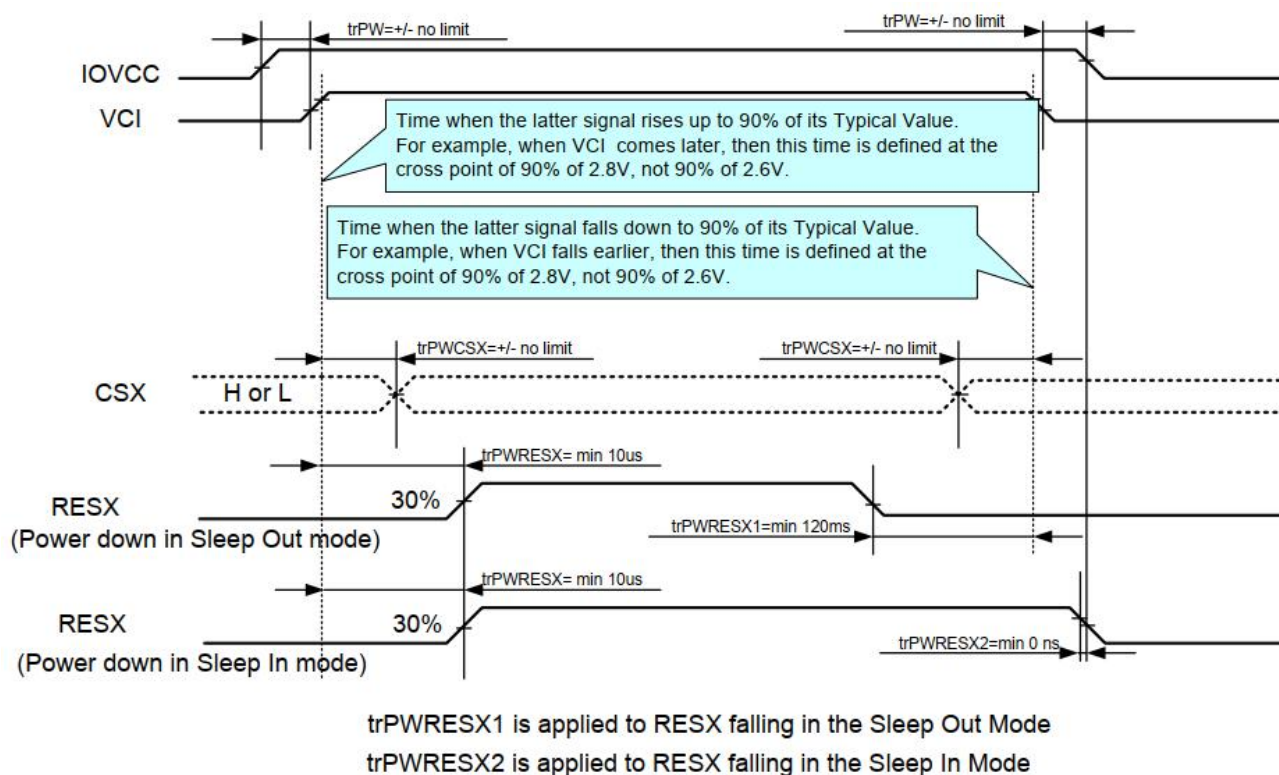
If the RESX line is held High or unstable by the host during Power On, then Hardware Reset must be applied after both VCI and IOVCC have been applied. Otherwise, the correct functionality is not guaranteed. There is no timing restriction upon this hardware reset.



Note: Unless otherwise specified, timings herein show the cross point at 50% of the signal power level.

5.3.1.2 Case 2 – RESX Line is Held Low by Host at Power ON

If the RESX line is held Low (and stable) by the host during Power On, then the RESX must be held low for a minimum of 10μsec after both VCI and IOVCC have been applied.



5.4 Timing Characteristics

8080 Series MCU Parallel Interface Timing Characteristics: 16/8-bit Bus

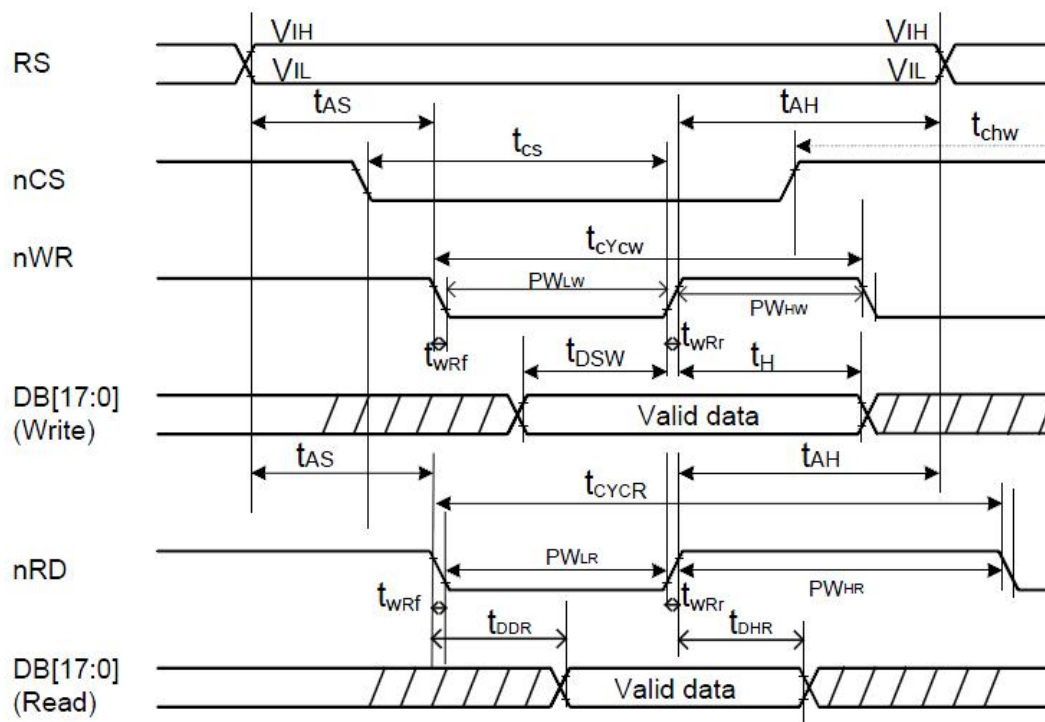
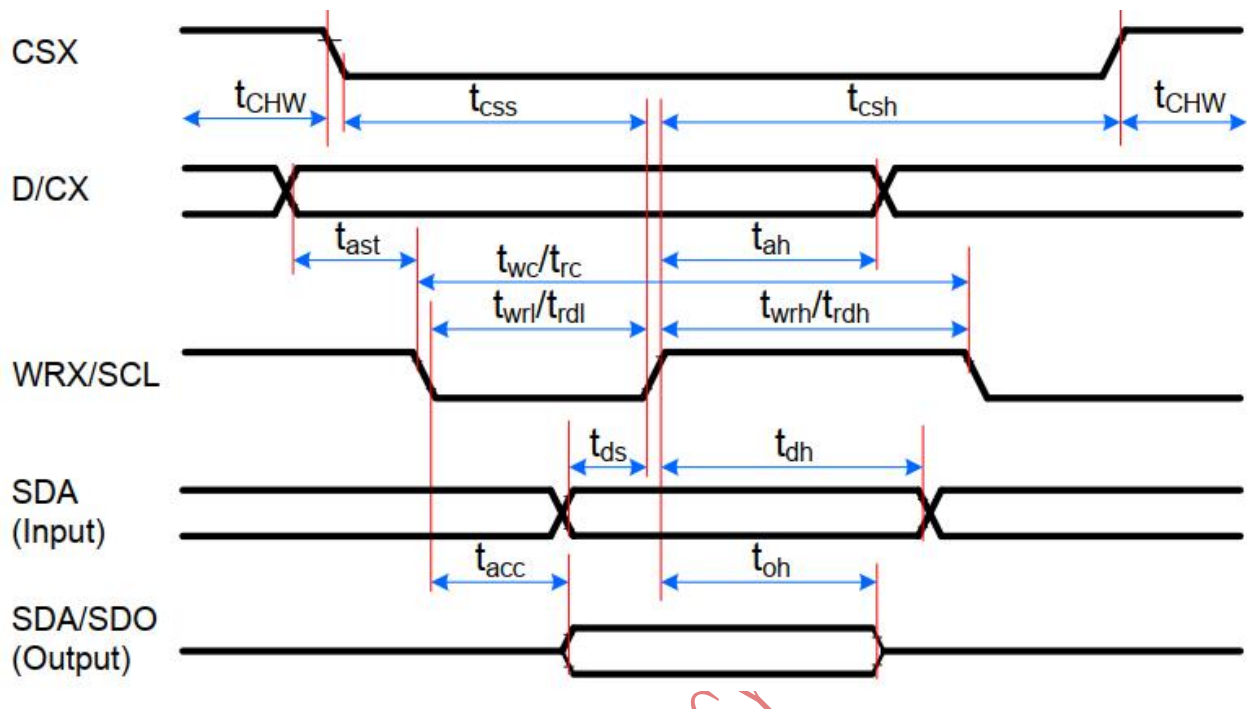


Figure 48 i80-System Bus Timing

Normal Write Mode (IOVCC = 1.65~3.3V)

	Item	Symbol	Unit	Min.	Typ.	Max.	Test Condition
Bus cycle time	Write	t_{CYCW}	ns	TBD	-	-	-
	Read	t_{CYCR}	ns	300	-	-	-
Write low-level pulse width		PW_{LW}	ns	TBD	-	500	-
Write high-level pulse width		PW_{HW}	ns	TBD	-	-	-
Read low-level pulse width		PW_{LR}	ns	150	-	-	-
Read high-level pulse width		PW_{HR}	ns	150	-	-	-
Write / Read rise / fall time		t_{WR}/t_{WRF}	ns	-	-	25	-
Setup time	Write (RS to nCS, E/nWR)	t_{AS}	ns	10	-	-	-
	Read (RS to nCS, RW/nRD)			5	-	-	-
Address hold time		t_{AH}	ns	5	-	-	-
Write data set up time		t_{DSW}	ns	10	-	-	-
Write data hold time		t_H	ns	15	-	-	-
Read data delay time		t_{DDR}	ns	-	-	100	-
Read data hold time		t_{DHR}	ns	5	-	-	-

5.5 Display Serial Interface Timing Characteristics (SPI system)



Signal	Symbol	Parameter	min	max	Unit	Description
CSX	t_{css}	Chip select time (Write)	15	-	ns	
	t_{csh}	Chip select hold time (Read)	15	-	ns	
	t_{CHW}	CS H pulse width	40	-	ns	
SCL	t_{wc}	Serial clock cycle (Write)	50	-	ns	
	t_{wrh}	SCL H pulse width (Write)	10	-	ns	
	t_{wrl}	SCL L pulse width (Write)	10	-	ns	
	t_{rc}	Serial clock cycle (Read)	150	-	ns	
	t_{rdh}	SCL H pulse width (Read)	60	-	ns	
	t_{rdl}	SCL L pulse width (Read)	60	-	ns	
D/CX	t_{as}	D/CX setup time	10	-	ns	
	t_{ah}	D/CX hold time (Write/Read)	10	-	ns	
SDA (Input)	t_{ds}	Data setup time (Write)	10	-	ns	
	t_{dh}	Data hold time (Write)	10	-	ns	
SDA/SDO (Output)	t_{acc}	Access time (Read)	10	50	ns	For maximum CL=30pF
	t_{od}	Output disable time (Read)	15	50	ns	For minimum CL=8pF

Notes:

1. $T_a = -30$ to $70\text{ }^{\circ}\text{C}$, $IOVCC = 1.65\text{V}$ to 3.3V , $V_{CI} = 2.5\text{V}$ to 3.3V , $AGND = DGND = 0\text{V}$, $T = 10\text{ }^{\circ}\text{C}$ $\pm 0.5\text{ns}$.
2. Does not include signal rising and falling times.

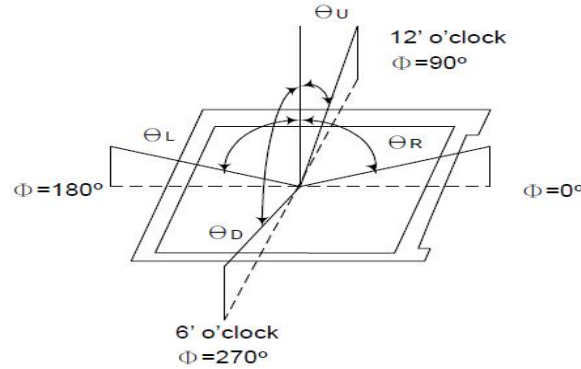
6.OPTICAL CHARACTERISTICS

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Contrast Ratio	C/R	$\theta = 0^\circ$	1000	1200	-	-	Note(4)
NTSC Ratio	S	$\theta = 0^\circ$	60	65	-	%	Note(7)
Luminance	L	$\theta = 0^\circ$	-	550	-	cd/m ²	Note(5)
Luminance uniformity	U _w	$\theta = 0^\circ$	70	80	-	%	Note(3)
Response Time	T _R + T _F	25 °C	-	30	35	ms	Note(2)
Color Coordination	W _X	$\theta = 0^\circ$ (Center) Normal viewing angle B/L On	-0.04	0.33	+0.04	NTSC (x,y)	Note(6)
	W _Y			0.37			
	R _X			0.660			
	R _Y			0.323			
	G _X			0.279			
	G _Y			0.574			
	B _X			0.134			
	B _Y			0.131			
Viewing Angle	θ_L	C/R>10	75	85	-	Degree	Note(1)
	θ_R		75	80	-		
	θ_U		75	85	-		
	θ_D		75	85	-		

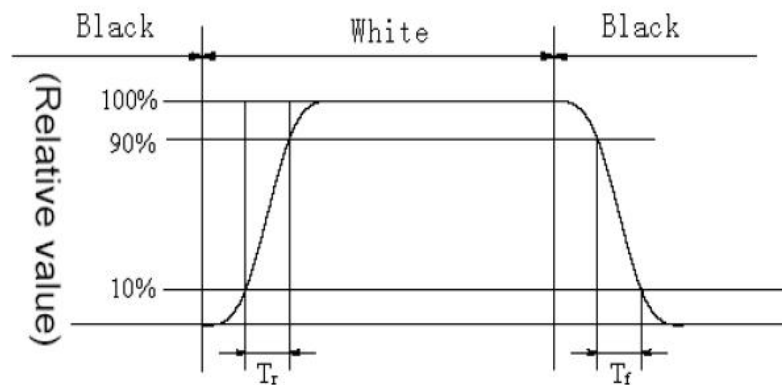
Test Conditions:

1. VDD=3.3V, $I_F=20\text{mA}$ (Backlight current), the ambient temperature is $+25^\circ\text{C}$.
2. The test systems refer to Note 8.

Note1: Definition of Viewing Angle: The viewing angle range that the CR>10

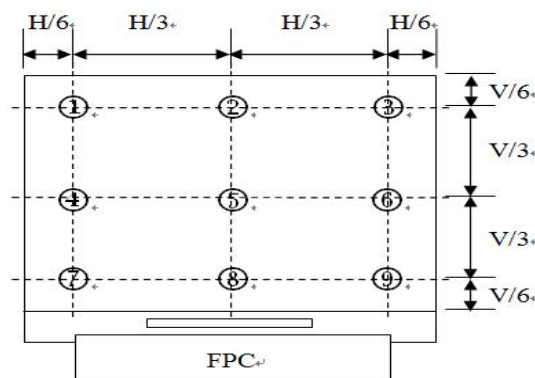


Note2: Definition of Response time: Sum of T_R and T_F



Note 3: Definition of Luminance Uniformity: Active area is divided into 9 measuring areas, every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity} = \frac{\text{Min Luminance of white among 9-points}}{\text{Max Luminance of white among 9-points}} \times 100\%$$



Note4: Definition of Contrast Ratio (CR): measured at the center point of panel

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

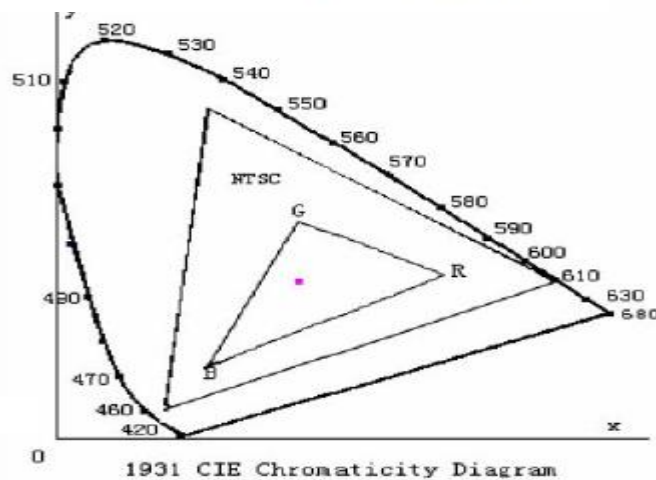
Note 5: Definition of Luminance: Center Luminance of white is defined as luminance values of 1 point average across the LCD surface.

Note 6: Definition of Color Chromaticity (CIE 1931)

Color coordinates of white & red, green, blue measured at center point of LCD.

Note 7: Definition of NTSC ratio:

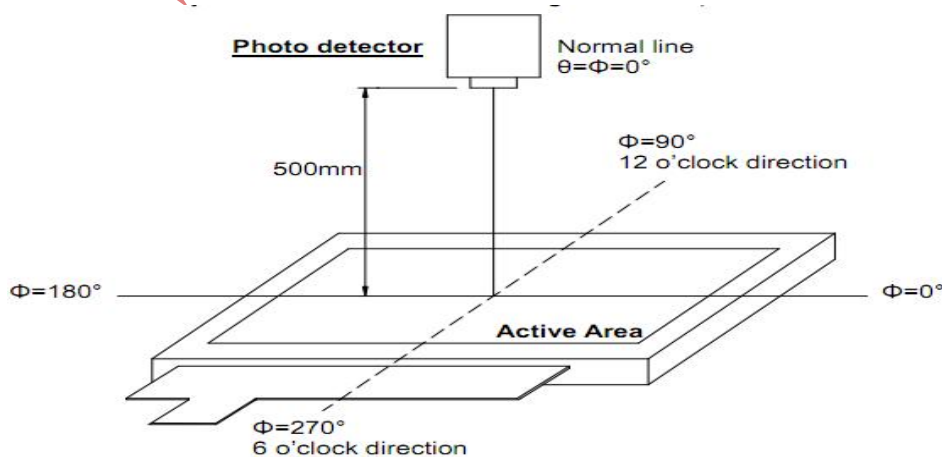
$$\text{NTSC ratio} = \frac{\text{Area of RGB triangle}}{\text{Area of NTSC triangle}}$$



Note 8: Definition of measurement system.

optical

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. (Response time is measured by Photo detector TOPCON BM-7, Field of view: 1°/Height: 500mm.)



7.RELIABILITY

Item	Test Condition	Remark
High Temperature Storage	Ta = +80°C / 96Hours	Note1,2,3
Low Temperature Storage	Ta = -30°C / 96Hours	Note1,2,3
High Temperature Operating	Ta = +70°C / 96Hours	Note1,2,3
Low Temperature Operating	Ta = -20°C / 96Hours	Note1,2,3
Temperature Cycle storage Test	-30°C/30min Δ +70°C /30min for 30cycles,Transfer time less than 5min	Note2,3
Thermal humidity storage Test	60°C x 90%RH / 96Hours	Note2,3
Package Vibration Test	Frequency: 10Hz~55Hz,Amplitude:1.5mm, 1 hrs for each direction of X, Y, Z	Note2
Packing shock test	Drop to the ground from 60cm height, 1 corner, 3 edges, 6 surfaces.	Note2

Inspection after Test:

Note1:Ta is the ambient temperature of samples.

Note 2: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but doesn't guarantee all the cosmetic specification.

Note 3: Before cosmetic and function tests , the product must have enough recovery time, at least 2 hours at room temperature.

Note 4: In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

8. PACKAGE DRAWING



第一步

将产品放入吸塑盘中，
LCD AA 面朝上，注意
防呆方向

第二步

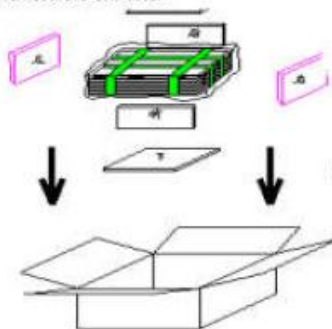
每一层吸塑盘与相邻
层，叠放时相错 180
度，最上层不放产品，
总叠加层数参考

第三步

检查无误后用胶带固
定吸塑盘，将捆好的吸
塑盘放入无尘带中并
封口；

First step

Putting products into the
tray,
LCD A.A faces Upward,
/pay attention to the



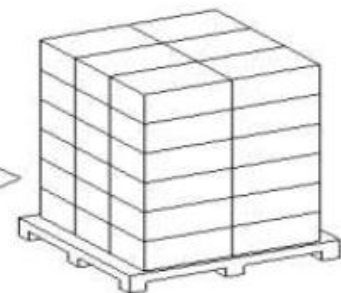
Second step

Neighbouring trays should be
staggered 180° while stacking
up.
on the top, there is an empty
tray without product



Third step

Taping up the tray
after inspection, and
put them into a PE



第四步

外箱内侧底部和四周
放上泡棉将包好的产
品装入纸箱，合盖；

第五步

最后胶带封箱，贴外箱
标签

第六步

将每箱整齐放在栈板
上并包裹最高可堆叠 6
层)

Fourth step

Putting EPE foams and
products with trays into
the carton;
Close the carton box

fifth step

Sealing the carton with
cellulose tape ;
Stick on a carton label,

sixth step

Placing the boxes together
on a pallet (6 layers at
most),